

Part Number: WP113SRSGWT

Super Bright Red
Super Bright Green

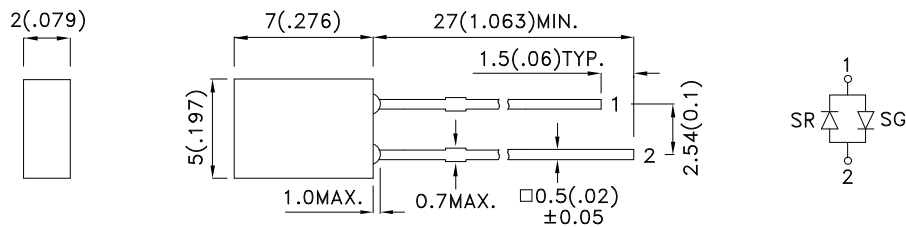
Features

- LOW POWER CONSUMPTION.
- RELIABLE AND RUGGED.
- EXCELLENT UNIFORMITY OF LIGHT OUTPUT.
- SUITABLE FOR LEVEL INDICATOR.
- LONG LIFE - SOLID STATE RELIABILITY.
- RoHS COMPLIANT.

Description

The Super Bright Red source color devices are made with Gallium Aluminum Arsenide Red Light Emitting Diode.
The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. Specifications are subject to change without notice.



Selection Guide

| Part No. | Dice | Lens Type | Iv (mcd) [2] @ 20mA | | Viewing Angle [1] |
|-------------|---------------------------|----------------|------------------------|------|----------------------|
| | | | Min. | Typ. | 2θ1/2 |
| WP113SRSGWT | Super Bright Red (GaAlAs) | WHITE DIFFUSED | 36 | 70 | 110° |
| | Super Bright Green (GaP) | | 7 | 10 | |

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Typ. | Max. | Units | Test Conditions |
|--------------------|--------------------------|--|-------------|------------|-------|---------------------------|
| λpeak | Peak Wavelength | Super Bright Red Super Bright Green | 660 565 | | nm | I _F =20mA |
| λD [1] | Dominant Wavelength | Super Bright Red Super Bright Green | 640 568 | | nm | I _F =20mA |
| Δλ1/2 | Spectral Line Half-width | Super Bright Red Super Bright Green | 20 30 | | nm | I _F =20mA |
| C | Capacitance | Super Bright Red Super Bright Green | 45 15 | | pF | V _F =0V;f=1MHz |
| V _F [2] | Forward Voltage | Super Bright Red Super Bright Green | 1.85 2.2 | 2.5 2.5 | V | I _F =20mA |

Notes:

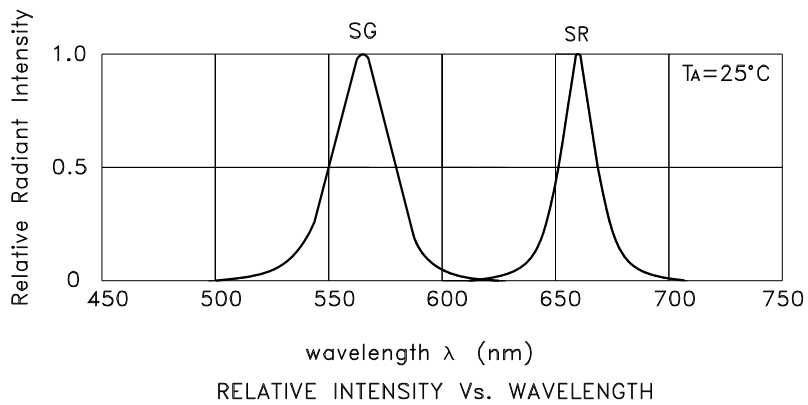
1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

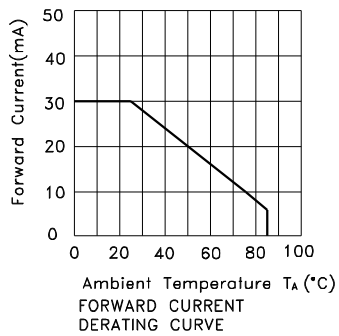
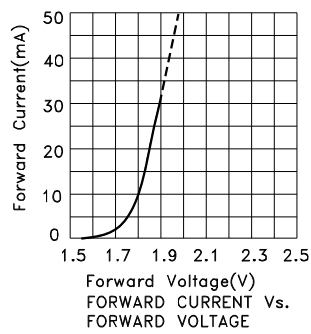
| Parameter | Super Bright Red | Super Bright Green | Units |
|---------------------------------|---------------------|--------------------|-------|
| Power dissipation | 75 | 62.5 | mW |
| DC Forward Current | 30 | 25 | mA |
| Peak Forward Current [1] | 155 | 140 | mA |
| Operating / Storage Temperature | -40°C To +85°C | | |
| Lead Solder Temperature [2] | 260°C For 3 Seconds | | |
| Lead Solder Temperature [3] | 260°C For 5 Seconds | | |

Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.
3. 5mm below package base.

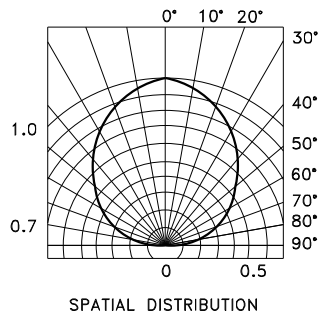
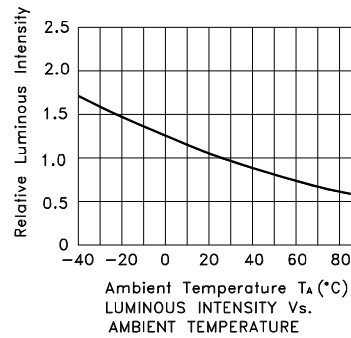
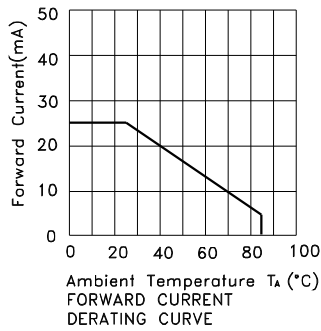
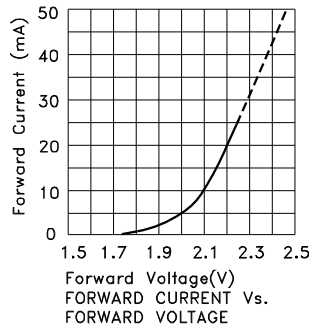


WP113SRSGWT Super Bright Red



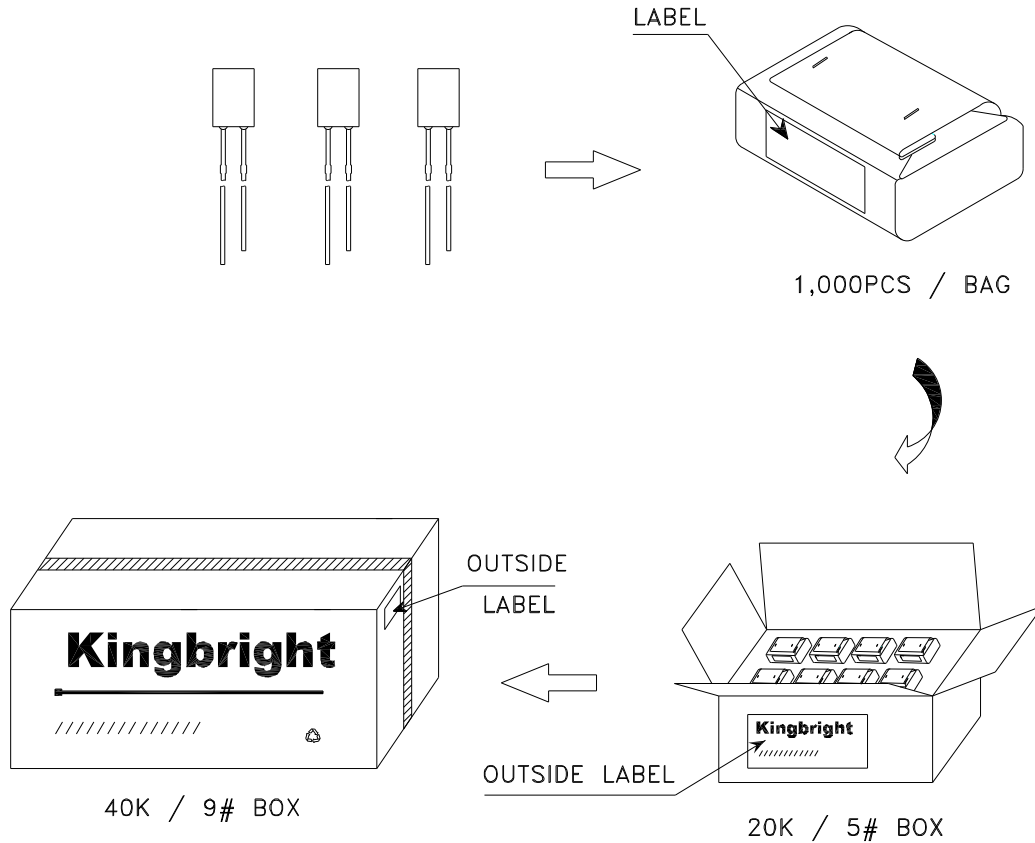
Kingbright

Super Bright Green



PACKING & LABEL SPECIFICATIONS

WP113SRSGWT



| | | | | |
|----------------------|--|----|----------|--------|
| <h1>Kingbright</h1> | | | | |
| Q.C. | <table border="1" style="margin: auto;"> <tr> <td style="text-align: center;">QC</td> </tr> <tr> <td style="text-align: center;">XX XX XX</td> </tr> <tr> <td style="text-align: center;">PASSED</td> </tr> </table> | QC | XX XX XX | PASSED |
| QC | | | | |
| XX XX XX | | | | |
| PASSED | | | | |
| TYPE NO : WP113xxx | | | | |
| QUANTITY : 1,000 pcs | | | | |
| S/N : XX | CODE: XX | | | |
| LOT NO : xxxxxxxx | | | | |
| RoHS Compliant | | | | |

LED MOUNTING METHOD

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.

(Fig. 1)

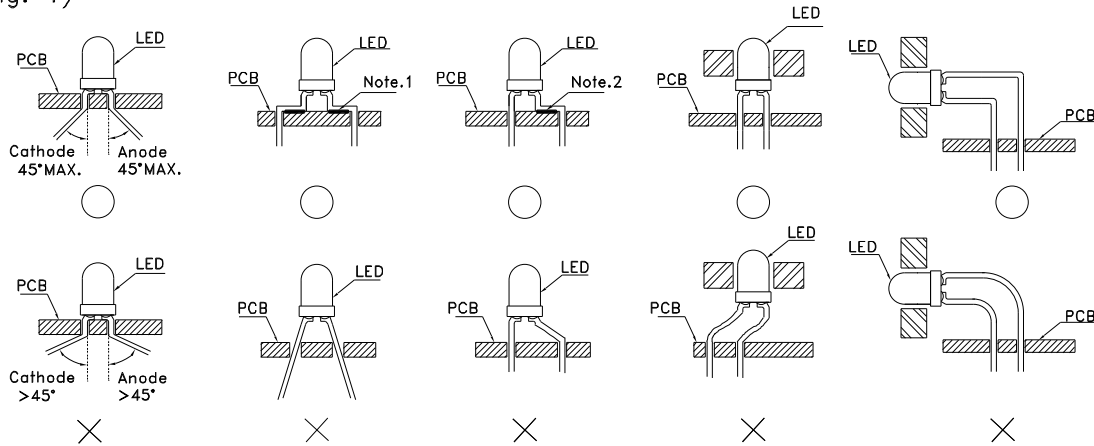


Fig.1

“○” Correct mounting method “×” Incorrect mounting method

Note 1-2 : Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit.

(Fig. 2)

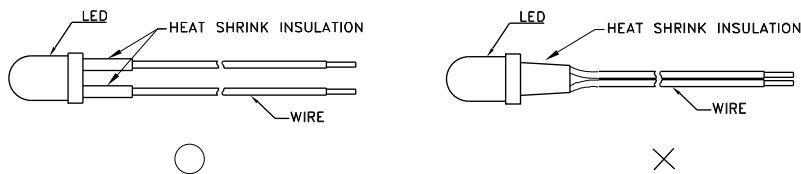


Fig. 2

3. Use stand-offs (Fig. 3) or spacers (Fig. 4) to securely position the LED above the PCB.

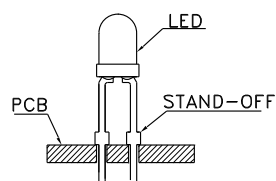


Fig. 3

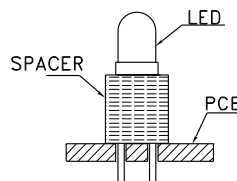


Fig. 4

LEAD FORMING PROCEDURES

1. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)

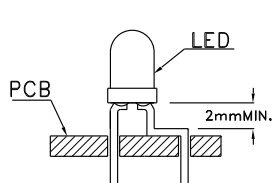


Fig. 5

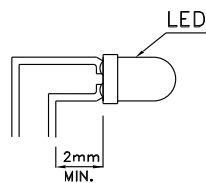


Fig. 6

2. Lead forming or bending must be performed before soldering, never during or after Soldering.
3. Do not stress the LED lens during lead-forming in order to fractures in the lens epoxy and damage the internal structures.
4. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)
5. Do not bend the leads more than twice. (Fig. 8)

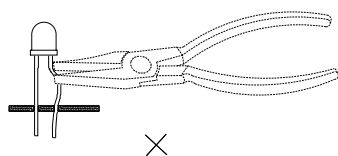


Fig. 7

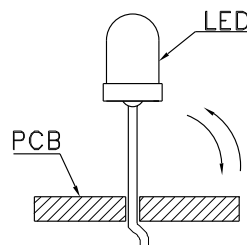


Fig. 8

6. After soldering or other high-temperature assembly, allow the LED to cool down to 50°C before applying outside force (Fig. 9). In general, avoid placing excess force on the LED to avoid damage. For any questions please consult with Kingbright representative for proper handling procedures.

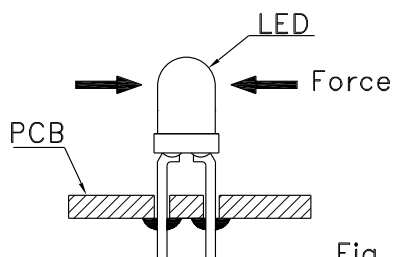


Fig. 9



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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